DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

PHASE CHANGE MEMORY DEVICE EMPLOYING THERMALLY INSULATING VOIDS, AND A METHOD OF MAKING SAME

the specification of whi Application No.	ch (check one) X is atta and was an	ached hereto or was filed on nended on	as (if applicable).
	e reviewed and understand amended by any amendm	I the contents of the above-ident ent referred to above.	ified specification,
I acknowledge the duty 1.56.	to disclose all information	n which is material to patentabili	ty as defined in 37 CFR §
application(s) for paten designated at least one	t or inventor's certificate, or country other than the Unit for patent or inventor's cer	J.S.C. § 119(a)-(d) or § 365(b) cor § 365(a) of any PCT International ted States, listed below and have trificate having a filing date before	onal application which also identified below
Prior Foreign Application	on(s)		Priority Claimed Yes No
Number	Country	Day/Month/Year Filed	
Number	Country	Day/Month/Year Filed	
I hereby claim the bene	fit under 35 U.S.C. § 119(6	e) of any United States provision	nal application(s) below.
Application Number	Filing Date		
Application Number	Filing Date		

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose all information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Number	Filing Date	Status: Patented, Pending, Abandoned	
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Application Number	Filing Date	Status: Patented, Pending, Abandoned	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of inventor BOMY CHEN		
Inventor's signature	•	
	Date	
Residence 10059 Carmen Road, Cupertino, CA 95014		
Citizenship United States of America		
Post Office Address 10059 Carmen Road, Cupertino, CA 95014		